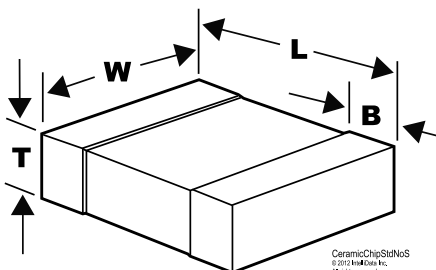


Ceramic, High Q, Microwave (CBR), 2.2 pF, +/-0.25 pF, 250 V, 0805, C0G, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I



Dimensions

L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
T	0.85mm +/-0.1mm
B	0.5mm +/-0.2mm

Packaging Specifications

Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	4000

General Information

Style:	SMD Chip
Series:	Microwave (CBR)
Chip Size:	0805
Description:	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features:	Ultra High Q, Low ESR, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
Miscellaneous:	Minimum Q = 844
Notes:	Solder Wave or Solder Reflow

Specifications

Capacitance:	2.2 pF
Capacitance Tolerance:	+/-0.25 pF
Voltage DC:	250 VDC
Dielectric Withstanding Voltage:	500 V
Temperature Range:	-55/+125C
Temperature Coefficient:	C0G
Dissipation Factor:	0.225%
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	10 GOhms
Quality Factor:	844